

**IN THE CLAIMS**

1. **(Previously Presented)** A thermal wave measuring method for contact-free measurement of geometrical or thermal features of a layer structure, comprising the steps of:

simultaneously driving a modulatable heat source with at least two predetermined discrete and differently modulated frequencies, thereby periodically heating said layer structure;

receiving infrared radiation emitted by said layer structure that is correspondingly modulated in intensity; and

evaluating said receiving infrared radiation as a function of a drive frequency on the basis of amplitude or phase by simultaneously interpreting corresponding drive frequencies.

2. **(Previously Presented)** The method according to claim 1, wherein said heat source is a laser, a laser diode, or a light-emitting diode.

3. **(Previously Presented)** The method according to claim 1, further comprising the step of: adapting discrete frequency parts of said drive frequencies to a measurement function.

4. **(Previously Presented)** The method according to claim 1, further comprising the step of: detecting predetermined frequencies with a lock-in evaluation.

5. **(Previously Presented)** The method according to claim 1, further comprising the step of: evaluating individual frequencies using a Fast Fourier Transform.

6. **(Previously Presented)** The method according to claim 4:  
further comprising the step of providing an additional evaluation based on a regression analysis or a neural network.
7. **(Previously Presented)** The method according to claim 1, further comprising the step of:  
calibrating said method to a specific layer structure utilizing mathematically specific, theoretical values as well as utilizing experimentally supported data.
8. **(Previously Presented)** The method according to claim 1, further comprising the step of:  
determining geometrical features given known thermal features of the layer structure.
9. **(Previously Presented)** The method according to claim 5:  
further comprising the step of providing an additional evaluation based on a regression analysis or a neural network.
10. **(Previously Presented)** The method according to claim 1, further comprising the step of:  
determining thermal features given known geometrical features of the layer structure.